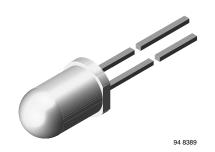
TSFF6210



Vishay Semiconductors

High Speed Infrared Emitting Diode, 870 nm, **GaAlAs Double Hetero**



TSFF6210 is an infrared, 870 nm emitting diode in GaAlAs double hetero (DH) technology with high radiant power and

high speed, molded in a clear, untinted plastic package.

FEATURES

- Package type: leaded
- Package form: T-1¾
- Dimensions (in mm) = Ø 5
- Peak wavelength: $\lambda_p = 870 \text{ nm}$
- High reliability
- High radiant power
- · High radiant intensity
- Angle of half intensity: $\varphi = \pm 10^{\circ}$
- · Low forward voltage
- Suitable for high pulse current operation
- High modulation bandwidth: f_c = 24 MHz
- · Good spectral matching with Si photodetectors
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

Note

Please see document "Vishay Material Category Policy": www.vishay.com/doc?99902

APPLICATIONS

- Infrared video data transmission between Camcorder and TV set
- · Free air data transmission systems with high modulation frequencies or high data transmission rate requirements
- · Smoke-automatic fire detectors

PRODUCT SUMMARY COMPONENT Ie (mW/sr) φ (deg) λ_p (nm) t_r (ns) **TSFF6210** 180 ± 10 870 15

Note

DESCRIPTION

Test conditions see table "Basic Characteristics"

| ORDERING INFORMATION | | | | | | | |
|----------------------|-----------|------------------------------|--------------|--|--|--|--|
| ORDERING CODE | PACKAGING | REMARKS | PACKAGE FORM | | | | |
| TSFF6210 | Bulk | MOQ: 4000 pcs, 4000 pcs/bulk | T-1¾ | | | | |

Note

MOQ: minimum order quantity

| ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified) | | | | | | | |
|---|--|-------------------|---------------|------|--|--|--|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT | | | |
| Reverse voltage | | V _R | 5 | V | | | |
| Forward current | | I _F | 100 | mA | | | |
| Peak forward current | $t_p/T = 0.5, t_p = 100 \ \mu s$ | I _{FM} | 200 | mA | | | |
| Surge forward current | t _p = 100 μs | I _{FSM} | 1 | A | | | |
| Power dissipation | | Pv | 180 | mW | | | |
| Junction temperature | | Тj | 100 | °C | | | |
| Operating temperature range | | T _{amb} | - 40 to + 85 | °C | | | |
| Storage temperature range | | T _{stg} | - 40 to + 100 | °C | | | |
| Soldering temperature | $t \le 5$ s, 2 mm from case | T _{sd} | 260 | °C | | | |
| Thermal resistance junction/ambient | J-STD-051, leads 7 mm, soldered on PCB | R _{thJA} | 230 | K/W | | | |



COMPLIANT

GREEN (5-2008)**





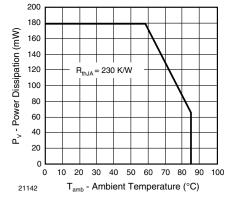


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

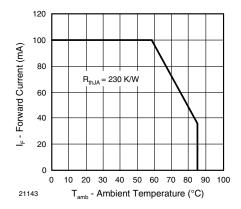


Fig. 1 - Forward Current Limit vs. Ambient Temperature

| BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified) | | | | | | | |
|---|---|------------------|------|--------|------|-------|--|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT | |
| Forward voltage | I _F = 100 mA, t _p = 20 ms | V _F | | 1.5 | 1.8 | V | |
| | I _F = 1 A, t _p = 100 μs | V _F | | 2.3 | 3.0 | V | |
| Temperature coefficient of V_F | I _F = 1 mA | TK _{VF} | | - 1.8 | | mV/K | |
| Reverse current | V _R = 5 V | I _R | | | 10 | μA | |
| Junction capacitance | $V_{R} = 0 V, f = 1 MHz, E = 0$ | Cj | | 125 | | pF | |
| De die at interación | $I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$ | l _e | 90 | 180 | 450 | mW/sr | |
| Radiant intensity | I _F = 1 A, t _p = 100 μs | l _e | | 1800 | | mW/sr | |
| Radiant power | I _F = 100 mA, t _p = 20 ms | фе | | 50 | | mW | |
| Temperature coefficient of ϕ_{e} | l _F = 100 mA | TKφ _e | | - 0.35 | | %/K | |
| Angle of half intensity | | φ | | ± 10 | | deg | |
| Peak wavelength | I _F = 100 mA | λ _p | | 870 | | nm | |
| Spectral bandwidth | l _F = 100 mA | Δλ | | 40 | | nm | |
| Temperature coefficient of λ_p | l _F = 100 mA | ΤΚλρ | | 0.25 | | nm/K | |
| Rise time | l _F = 100 mA | t _r | | 15 | | ns | |
| Fall time | l _F = 100 mA | t _f | | 15 | | ns | |
| Cut-off frequency | $I_{DC} = 70$ mA, $I_{AC} = 30$ mA pp | f _c | | 24 | | MHz | |
| Virtual source diameter | | d | | 3.7 | | mm | |



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BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

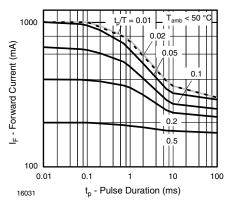


Fig. 2 - Pulse Forward Current vs. Pulse Duration

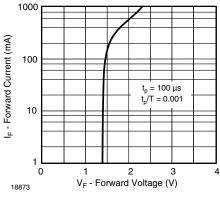


Fig. 3 - Forward Current vs. Forward Voltage

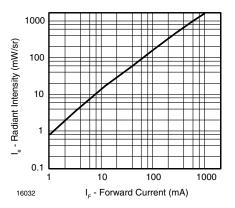


Fig. 4 - Radiant Intensity vs. Forward Current

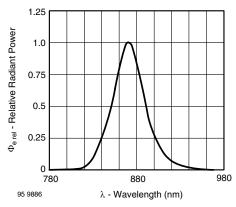


Fig. 5 - Relative Radiant Power vs. Wavelength

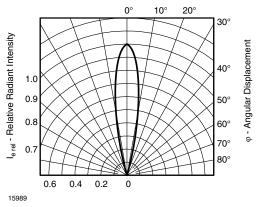


Fig. 6 - Relative Radiant Intensity vs. Angular Displacement

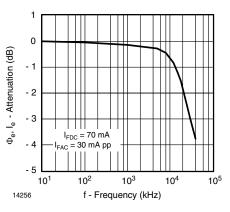


Fig. 7 - Attenuation vs. Frequency

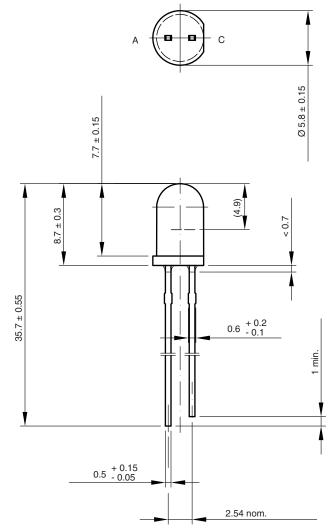
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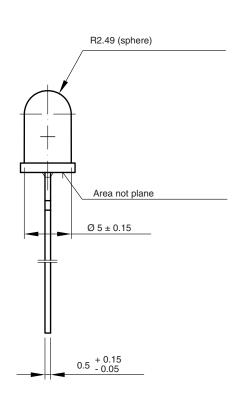
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PACKAGE DIMENSIONS in millimeters



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technical drawings according to DIN specifications

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